DECLARATION AND POWER OF ATTORNEY FOR PATENT APPLICATION

DOCKETNO, TS02-360

As a below named Inventor, I hereby declare that:

the specification of which (check one)

My residence, post office address and citizenship are as stated below next to my name;

I believe I am the original, first and sole inventor (if only ne name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled Improved Adhesion Of CU And Etch Stop Layer For CU Alloy

X is attached hereto.			
was filed on			
Application Serial No.			-
and was amended on			
I hereby state that I have reviewed and ur amended by any amendment referred to a	oplicable) iderstand the contents of the bove.	above Identified specification include	ling the claims, as
I acknowledge the duty to disclose inform Title 37, Code of Federal Regulations, §1	nation which is material to the	ne examination of this application in a	ccordance with
I hereby claim foreign priority benefits un inventor's certificate listed below and having a filing date before that of the app Prior Foreign Application(s)	nder Title 35, United States (ve also identified below any dication on which priority is	Code §119 of any foreign application foreign application for patent or investigation for patent or investigation.	(s) for patent or mor's certificate
The configuration of the confi		Priority Clai	med:
(Number)	(Country)	(Day/Month/Year Filed)	
(Number)	(Country)	(Day/Month/Year Filed)	
I hereby claim the benefit under Title 35, as the subject matter of each of the claims manner provided by the first paragraph of information as defined in Title 37, Code application and the national or PCT international	United States Code §120 of sof this application is not differed as the states Code of Federal Regulations, §1.5 national filing date of this applications.	any United States application(s) liste sclosed in the prior United States apple, §112, I acknowledge the duty to di 6(a) which occurred between the filin plication:	d below and, insofar lication in the sclose material g date of the prior
(Application Scrial No.)	(Filing Date) (Statu	s) (patented, pending, abandoned)	
I hereby declare that all statements made belief are believed to be true; and further the like so made are punishable by fine or and that such willful false statements may	herein of my own knowledg that these statements were imprisonment, or both, und jeopardize the validity of the	e are true and that all statements made nade with the knowledge that willful i der Section 1001 of Title 18 of the Un he application or any patent issued the	e on information and false statements and lited States Code reon.
POWER OF ATTORNEY: As a named is application and transact all business in the	nventor, I hereby appoint the	e following attorney(s) and/or agent(s) to prosecute this
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